

LMC:ejv 01/12/11 23-65037-09 E-1861 PCT US

**INFORMATION DISCLOSURE STATEMENT
BY APPLICANT**

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| Attorney Docket Number | 23-65037-09 |
| Application Number | 10/581,281 |
| Filing Date | May 31, 2006 |
| First Named Inventor | Larry C. Olsen |
| Art Unit | 1795 |
| Examiner Name | Golam Mowla |

U.S. PATENT DOCUMENTS

| Examiner Initials* | Cite No. (optional) | Document Number Number-Kind Code (if known) | Issue or Publication Date | Name of Patentee or Applicant |
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FOREIGN PATENT DOCUMENTS

| Examiner Initials* | Cite No. (optional) | Foreign Patent Document Country Code-Number-Kind Code (if known) | Issue or Publication Date | Name of Patentee or Applicant |
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OTHER DOCUMENTS

| Examiner Initials* | Cite No. (optional) | |
|--------------------|---------------------|---|
| | | Final Office action from the U.S. Patent and Trademark Office for U.S. Patent Application No. 10/726,744, dated December 6, 2010. |
| | | Mattox, D. M., Handbook of Physical Vapor Deposition (PVD) Processing. William Andrew Publishing/Noyes., Chapter 6, pp. 343-405 (1998). |
| | | Office action from the U.S. Patent and Trademark Office in U.S. Patent Application No. 11/004,611, dated December 17, 2010. |
| | | Office action from the U.S. Patent and Trademark Office in U.S. Patent Application No. 11/864,877, dated November 23, 2010. |
| | | Restriction Requirement from the U.S. Patent and Trademark Office in U.S. Patent Application No. 11/864,877, dated October 18, 2010. |
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EXAMINER
SIGNATURE: /Golam Mowla/DATE
CONSIDERED: 07/29/2011

* Examiner: Initial if reference considered, whether or not in conformance with MPEP 609. Draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.

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